

EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	5189	(257/686,690).CCLS	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/06/22 17:52
L2	5420	(257/777,778).CCLS	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/06/22 17:53
L3	6	((("20030160316") or ("20020041027") or ("20010006257")).PN.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/06/22 17:54
L5	2	("6593645").PN.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/06/22 17:56
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L12	57049	stack\$3 with (chip semiconductor die wafer)	US-PGPUB; USPAT; USOCR	OR	ON	2008/06/22 17:58
L13	145906	(via through adj hole throughhole) with (chip semiconductor die wafer)	US-PGPUB; USPAT; USOCR	OR	ON	2008/06/22 17:58
L14	16737	12 and 13	US-PGPUB; USPAT; USOCR	OR	ON	2008/06/22 17:58
L15	59	12 and intermediate adj chip	US-PGPUB; USPAT; USOCR	OR	ON	2008/06/22 17:59
L16	44	(via thorough adj hole throughhole) with intermediate adj chip	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/22 18:00
L18	378	intermediate adj chip	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/22 18:01

L19	1915	high with ohmic with substrate	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/22 18:02
L20	640	high near4 ohmic with substrate	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/22 18:02
L21	116082	hole with (chip semiconductor die wafer)	US-PGPUB; USPAT; USOCR	OR	ON	2008/06/22 18:03
L22	13084	12 and 21	US-PGPUB; USPAT; USOCR	OR	ON	2008/06/22 18:03
L23	46	19 and 22	US-PGPUB; USPAT; USOCR	OR	ON	2008/06/22 18:03
L24	30	18 and 22	US-PGPUB; USPAT; USOCR	OR	ON	2008/06/22 18:04

6/22/08 6:04:30 PM

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